

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

Assignment ID: PATI628426

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Sangu Chon	10/29/2024
<b>RECEIVING PARTY DATA</b>	
<b>Company Name:</b>	Angstrom Semiconductor LLC
<b>Street Address:</b>	50 Makamah Beach Road
<b>City:</b>	Northport
<b>State/Country:</b>	NEW YORK
<b>Postal Code:</b>	11768
<b>PROPERTY NUMBERS Total: 2</b>	
<b>Property Type</b>	<b>Number</b>
<b>Patent Number:</b>	11609088
<b>Application Number:</b>	62848211
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	9732010660
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	(973)486-4114
<b>Email:</b>	mail@budzyn-ip.com
<b>Correspondent Name:</b>	Ludomir A. Budzyn
<b>Address Line 1:</b>	Budzyn IP Law, LLC
<b>Address Line 2:</b>	120 Eagle Rock Avenue, Suite 328
<b>Address Line 4:</b>	East Hanover, NEW JERSEY 07936
<b>ATTORNEY DOCKET NUMBER:</b>	3005-82
<b>NAME OF SUBMITTER:</b>	Teresa Maslonka
<b>SIGNATURE:</b>	Teresa Maslonka
<b>DATE SIGNED:</b>	11/13/2024
<b>Total Attachments: 3</b>	
source=Document 1_USA_Revised Supplementary Assignment (Sangu Chon - Ansgtrom Semiconductor LLC)#page1.tiff	
source=Document 1_USA_Revised Supplementary Assignment (Sangu Chon - Ansgtrom Semiconductor LLC)#page2.tiff	



## WORLDWIDE PATENT ASSIGNMENT

This PATENT ASSIGNMENT (this "Patent Assignment") is made and entered into as of January 1<sup>st</sup>, 2024 between **Sangu Chon**, a citizen of the United States of America, having an address at 291 Liberty St, Apt 51 Little Ferry New Jersey 07643, United States of America, ("Assignor"), and **Angstrom Semiconductor LLC**, a company incorporated under the laws of the United States of America, having an address at 50 Makamah Beach Road, Northport, New York 11768, United States of America ("Assignee").

WHEREAS, pursuant to, their respective contractual obligations including under a Patent Assignment and Revenue Share Agreement dated January 1<sup>st</sup>, 2024, Assignor desires to sell, convey, transfer and assign to Assignee, and Assignee desires to accept the sale,

conveyance, transfer and assignment from the Assignor, the Assignor's worldwide right, title and interest in, to and under all patents and patent applications, and all applications and registrations therefor set forth in Schedule A hereto, together with all reissuances, divisions, renewals, revisions, extensions (including any supplementary protection certificates), reexaminations, provisionals, continuations and continuations-in-part with respect thereto and including all foreign equivalents and in and to the inventions represented thereby (hereinafter collectively referred to as the "**Patents**").



NOW, THEREFORE, in consideration of the sum of USD One (US \$ 1) and such other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, Assignor does hereby sell, convey, transfer and assign to Assignee, and Assignee hereby accepts the transfer and assignment of, all of Assignor's worldwide right, title and interest in, to and under the Patents identified in Schedule A and all rights to the inventions described and claimed therein, together with the right to claim priority in all foreign countries identified on Schedule A in accordance with international law, any and all rights corresponding to such Patents in foreign countries identified in Schedule A throughout the world and all of Assignor's rights and actions for past infringement and/or misappropriation, all to be held and enjoyed by Assignee, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by Assignor had this Patent Assignment not been made.

This Patent Assignment and the rights and obligations hereunder shall be binding upon and inure solely to the benefit of the parties hereto and their respective successors and permitted assigns.

Assignor hereby covenants that no assignment, sale, license, agreement or encumbrance has been or will be entered into which would conflict with this Patent Assignment. Assignor further covenants not to challenge, or assist or participate in any third party challenge to, the assigned Patents, whether by litigation, invalidity proceedings, post grant review, inter partes review, covered business method review, reexamination, or otherwise.

This Patent Assignment may be executed in two or more counterparts, each of which shall be deemed to be an original and all of which shall be deemed to constitute the same Patent Assignment. This Patent Assignment may be executed by facsimile or pdf signature and a facsimile or pdf signature shall constitute an original for all purposes.

This Agreement shall be effective as on the earliest date by which the signatures of both the Assignor and Assignee have been affixed hereto.

Sangu CHON		Angstrom Semiconductor LLC	
Signature:		Signature:	
		Name:	Robert Maire
		Title:	CEO
Date:	10/29/2024	Date:	

**Annexure A - Patents**

<b>S.No.</b>	<b>Country</b>	<b>Application Number</b>	<b>Patent Number</b>
1.	USA	16/860,943	11,609,088
2.	USA	62/848,211	--
3.	Japan	2020-083448	7,124,008
4.	Taiwan	109115707	I761832
5.	Korea	10-2020-0030659	10-2418198
6.	China	202010317565.8	--